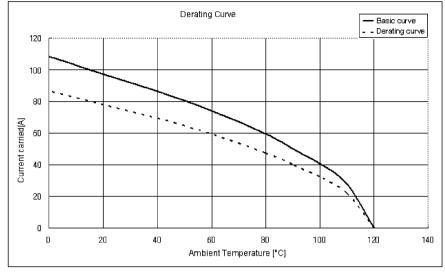
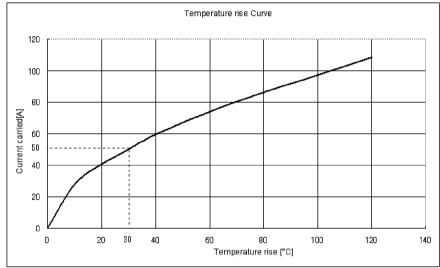
	OPERATING		-55 °C TO +85 °	°C (1) (2)	STORAG		_	-10 °C TO +60 °	C (3)		
	TEMPERATURE RANGE OPERATING HUMIDITY RANGE VOLTAGE		-55 °C 10 +85 °	U (17 (4)		ATURE RANG	-	-10°C 10 +60°	U ™		
RATING			RH 90 % MAX	(2) (4)	RANGE			RH 70 % MAX	(3) (4)		
			300 V DC/AC		CURRE	NT		50A (TEMPERATURE RISE 3		MAX	
	<u> </u>			CIFICAT	IONS			JOSET (TERM ENVIRONMENTAL TRIBE		1417 0 0	
IT	EM		TEST METHOD		10.10	RF		REMENTS	Тот	A	
CONSTRI			TEST WETTION	<u>'</u>		11/1	QUI	ILIVILIVIO	اها	17	
	XAMINATION	N VISUAL A	ND WITH MEASURING INSTR	UMENT	IAC	CORDING TO I	DRAV	VING	×	×	
			ED VISUALLY	OWE IT		OOKBING TO	J1 () (V	VII. (3	×	+	
ELECTRIC	CHARAC	TERISTI	CS								
			100 mA AND 20 mV OPEN CIRCUIT MAX.			2 mΩMAX. <sup>(5)</sup> MATED WITH IT-PM-2S-DIR IT-PD-2S-DIR			×		
INSULATION RESISTANCE [EIA-364-21] 500 V DC						00 ΜΩΜΙΝ.			×		
VOLTAGE PROOF EIA-364-20]			C FOR 1 MINUTE			FLASHOVER	OR B	REAKDOWN.	×		
	CAL CHA										
INSERTION WITHDRAW EIA-364-13]	AND AL FORCES	1	MEASURED WITH RESPECT TO APPLICABLE CONNECTORS			INSERTION FORCE: 50 N MAX. WITHDRAWAL FORCE: 3 N MIN.					
MECHANICA OPERATION		100 TIMES	100 TIMES INSERTION AND EXTRACTION			① CONTACT RESISTANCE: 2 mΩ MAX. (5) ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS					
[EIA-364-09]  RANDOM VIBRATION FRE			FREQUENCY : 50 TO 2000 Hz				ΔΙΓΩ	SCONTINI IITV OF 1 OD	-	+	
EIA-364-28]	BRATION	POWER S FOR 90 M * The tes	POWER SPECTRAL DENSITY: 0.1 g²/Hz FOR 90 MINUTES IN THREE DIRECTIONS  * The test sample fixes PCB by spacers other than the connector.				<ul> <li>① NO ELECTRICAL DISCONTINUITY OF 1 μs OR MORE</li> <li>② NO DAMAGE, CRACK OR LOOSENESS OF PARTS</li> </ul>				
[EIA-364-27] 18 TIMES * The te			0 m/s <sup>2</sup> , DURATION OF PULSE: 11 ms TIMES TOTAL, 3 EACH DIRECTION, 3 AXIS The test sample fixes PCB by spacers other than the connector.						×		
ENVIRON	MENTAL	CHARAC	TERISTICS		•					•	
[EIA-364-32] TIME:		TIME:	EMPERATURE: $-55 \rightarrow 20 \sim 35 \rightarrow 85 \rightarrow 20 \sim 35 ^{\circ}C$ ME: $30 \rightarrow 5 \text{ MAX} \rightarrow 30 \rightarrow 5 \text{ MAX} \text{ min.}$ NDER 10 CYCLES			<ul> <li>① CONTACT RESISTANCE: 2 mΩ MAX. (5)</li> <li>② INSULATION RESISTANCE: 100 MΩ MIN.</li> <li>③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS</li> </ul>					
		@ 65 °C, 5	@ 25 °C, 80% RH: 60 MIN DWELL TIME 30 MIN RAMP TIME @ 65 °C, 50% RH: 60 MIN DWELL TIME UNDER 24 CYCLES								
DRY HEAT [EIA-364-17]		EXPOSED	SED AT 105 °C, 120 hr			① CONTACT RESISTANCE: 2 mΩ MAX. (5) ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS			×		
MIXED FLOWING GAS EIA-364-65]		Cl <sub>2</sub> : 10 ppl	D AT 30 °C, 70% ob, NO <sub>2</sub> : 200 ppb, H <sub>2</sub> S : 10 ppb, SO <sub>2</sub> : 100 ppb D 7 DAYS, MATED 7 DAYS			① CONTACT RESISTANCE: 2 m Ω MAX. (5) ② NO HEAVY CORROSION					
COUN	IT	L DESCRIPTION	ON OF REVISIONS		DESIGNE	D		CHECKED	DA	DATE	
<u>∕</u> MEMARKS											
(1) INCLUDE TEMPERATURE RISE CAUSED BY CURRENT-CARRYING. (2) OPERATING TEMPERATURE SHOULD BE -55 TO 55°C WHEN HUMIDITY EXCEEDS 80% RH.						APPRO\		HS. OKAWA		11. 12. 16	
(3) "STORAGE" MEANS A LONG-TERM STORAGE STATE FOR THE UNUSED PRODUCT BEFORE ASSEMBLY TO PCB.  (4) NO DEW CONDENSATION IS PERMITTED.						CHECK	ECKED KI. HIROKAWA  SIGNED KN. SHIBUYA		11. 12. 15		
			ICLUDES 2 CONTACT POINTS AND THE BULK RESISTAI			DESIGN		KN. SHIBUYA	11. 1		
			rance Test X:Applicable Test D			RAWING NO.		ELC4-339735-00			
Note; QT:Qu	alification Tes	st AT:Assui	ance lest X:Applicable le	73L							
Note; QT:Qu			CATION SHEET		PART NO			IT-P-2P-35H	00		

SPECIFICATIONS

ITEM TEST METHOD REQUIREMENTS QT AT

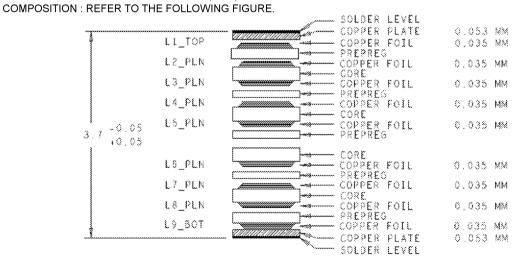
## [REFERENCE] DERATING CURVE AND TEMPERATURE RISE CURVE





<TEST BOARD CONDITIONS>

SIZE: 80 x 68 x t3.7 mm (9 LAYERS PCB) MATERIAL: GLASS FIBER, EPOXI RESIN (FR-4)



Note QT:C	ualification Test AT:Assurance Test X:Applicable Test	DRAWIN	IG NO.	ELC4-339735-00		
HRS	SPECIFICATION SHEET	PART NO.	IT-P-2P-35H			
	HIROSE ELECTRIC CO., LTD.	CODE NO	CL636	5-0602-2-00	<b>A</b>	2/2